



## Power line chokes

Current-compensated ring core triple chokes  
440/ 250 V AC, 6 ... 25 A, 1.3 ... 6 mH

**Series/Type:** B82747F

**Date:** July 2012

Current-compensated ring core triple chokes

Rated voltage 440/ 250 V AC


Rated current 6 ... 25 A

Rated inductance 1.3 ... 6 mH

Construction

- Current-compensated ring core triple choke
- Ferrite core
- Polycarbonate case (UL 94 V-0)
- Polyurethane potting (UL 94 V-0)
- For through-hole fixing
- Sector winding

Features

- > 1% stray inductance for symmetrical interference suppression
- High currents
- Design complies with EN 60938-2 (VDE 0565-2)
- ENEC (VDE) approval 
- RoHS-compatible

Applications

- Suppression of common-mode interferences
- Switch-mode power applications

Terminals

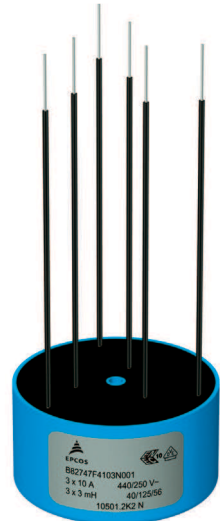
- Ends of winding wires
- Hot dip tinned

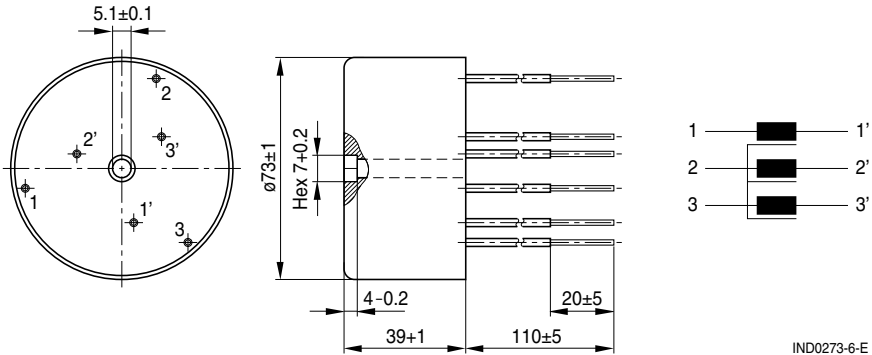
Marking

Manufacturer, approval marks, ordering code, rated current, rated voltage, rated inductance, climatic category, date of manufacture (YYWW.internal ID code), factory identification code

Delivery mode

Blister tray in cardboard box




**Dimensional drawing and pin configuration**


Dimensions in mm  
Tolerances acc. ISO 2768-c

**Technical data and measuring conditions**

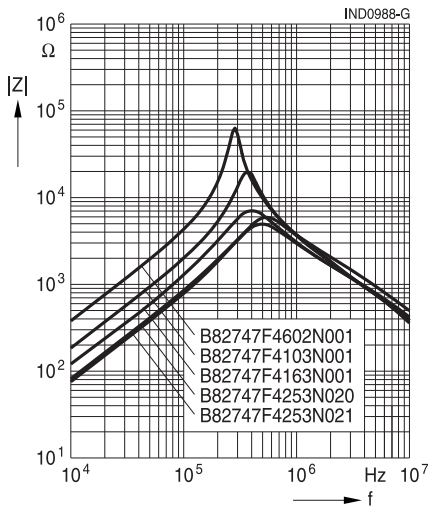
Rated voltage $V_R$	440/250 V AC (50/ 60 Hz)
Test voltage $V_{test}$	2500 V AC, 2 s (line/ line)
Rated temperature $T_R$	+40 °C or +60 °C
Rated current $I_R$	Referred to 50 Hz and rated temperature
Rated inductance $L_R$	Measured with Agilent 4284A at 10 kHz, 0.1 mA, +20 °C Inductance is specified per winding.
Inductance tolerance	±30% at +20 °C
Inductance decrease $\Delta L/ L_0$	< 20% at DC magnetic bias with $I_R$ , +20 °C
Stray inductance $L_{stray,typ}$	Measured with Agilent 4284A at 10 kHz, 5 mA, +20 °C, typical value
DC resistance $R_{typ}$	Measured at +20 °C, typical values, specified per winding
Solderability (lead free)	Sn96.5Ag3.0Cu0.5: +(245 ±5) °C, (3 ±0.3) s Wetting of soldering area ≥ 95% (to IEC 60028-2-58, test Ta)
Climatic category	40/ 125/ 56 (to IEC 60068-1)
Storage conditions (packaged)	-25 °C ... +40 °C, ≤ 75% RH
Weight	Approx. 350 g
Approvals	EN 60938-2

**Characteristics and ordering codes**

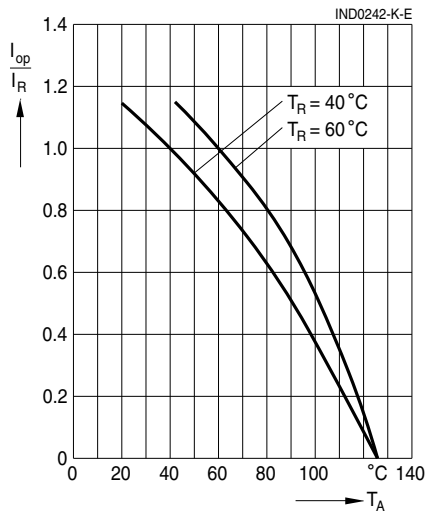
$I_R$ A	$L_R$ mH	$L_{stray,typ}$ $\mu$ H	$R_{typ}$ m $\Omega$	$T_R$ $^{\circ}$ C	Wire $\varnothing$ mm	Ordering code	Approvals 
6	6.0	145	50	60	1.0	B82747F4602N001	X
10	3.0	64	20	60	1.4	B82747F4103N001	X
16	2.0	38	12	60	1.6	B82747F4163N001	X
25	1.3	22	7.5	40	1.8	B82747F4253N020	X
25	1.3	22	4.7	60	2.24	B82747F4253N021	X

× = approval granted

**Impedance  $|Z|$  versus frequency  $f$**   
measured with windings in parallel at +20  $^{\circ}$ C,  
typical values



**Current derating  $I_{op}/I_R$**   
**versus ambient temperature  $T_A$**



## Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there. Derating must be applied in case the ambient temperature in the application exceeds the rated temperature of the component.
  - Ensure the operation temperature (which is the sum of the ambient temperature and the temperature rise caused by losses / self-heating) of the component in the application does not exceed the maximum value specified in the climatic category.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.  
Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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